

# 16-Bit, 100 kSPS PulSAR, Differential ADC in MSOP

# AD7684

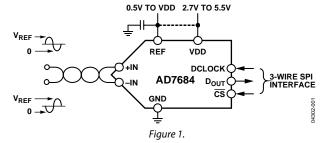
#### **FEATURES**

16-bit resolution with no missing codes Throughput: 100 kSPS INL: ±1 LSB typical, ±3 LSB maximum True differential analog input range: ±V<sub>REF</sub> 0 V to V<sub>REF</sub> with V<sub>REF</sub> up to VDD on both inputs Single-supply operation: 2.7 V to 5.5 V Serial interface SPI®-/QSPI-™/MICROWIRE-™/DSP-compatible Power dissipation 4 mW @ 5 V 1.5 mW @ 2.7 V/ 150 µW @ 2.7 V/10 kSPS Standby current: 1 nA 8-lead MSOP package

#### **APPLICATIONS**

Battery-powered equipment Data acquisition Instrumentation Medical instruments Process control

### APPLICATION DIAGRAM



#### Table 1. MSOP, QFN (LFCSP)/SOT-23 14-/16-/18-Bit PulSAR ADC

	100	250	400 kSPS to	≥ 1000	ADC
Туре	kSPS	kSPS	500 kSPS	kSPS	Driver
18-Bit True		AD7691	AD7690	AD7982	ADA4941
Differential				AD7984	ADA4841
16-Bit True	AD7684	AD7687	AD7688		ADA4941
Differential			AD7693		ADA4841
16-Bit Pseudo	AD7680	AD7685	AD7686	AD7980	ADA4841
Differential	AD7683	AD7694			
14-Bit Pseudo Differential	AD7940	AD7942	AD7946		ADA4841

#### **GENERAL DESCRIPTION**

The AD7684 is a 16-bit, charge redistribution, successive approximation, PulSAR\* analog-to-digital converter (ADC) that operates from a single power supply, VDD, between 2.7 V to 5.5 V. It contains a low power, high speed, 16-bit sampling ADC with no missing codes, an internal conversion clock, and a serial, SPI-compatible interface port. The part also contains a low noise, wide bandwidth, short aperture delay, track-and-hold circuit. On the  $\overline{\text{CS}}$  falling edge, it samples the voltage difference between +IN and –IN pins. The reference voltage, REF, is applied externally and can be set up to the supply voltage. Its power scales linearly with throughput.

The AD7684 is housed in an 8-lead MSOP, with an operating temperature specified from  $-40^{\circ}$ C to  $+85^{\circ}$ C.

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

# TABLE OF CONTENTS

Features 1
Applications1
Application Diagram1
General Description
Revision History
Specifications
Timing Specifications 5
Absolute Maximum Ratings
ESD Caution
Pin Configuration and Function Descriptions7
Terminology
Typical Performance Characteristics9
Application Information12
Circuit Information12

	Converter Operation	. 12
	Transfer Functions	. 12
	Typical Connection Diagram	. 13
	Analog Inputs	. 13
	Driver Amplifier Choice	. 13
	Voltage Reference Input	. 14
	Power Supply	. 14
	Digital Interface	. 14
	Layout	. 14
	Evaluating the Performance of the AD7684	. 14
(	Dutline Dimensions	. 15
	Ordering Guide	. 15

### **REVISION HISTORY**

10/07—Rev. 0 to Rev. A	
Changes to Table 1	1
Changes to Table 2	3
Changes to Layout	5
Changes to Table 6 and Layout	6
Changes to Table 7	7
Changes to Figure 15 Caption	. 10
Changes to Figure 21	. 12
Changes to Figure 22 and Analog Inputs Section	. 13
Changes to Table 9, Digital Interface Section, and Evaluating	
the Performance of the AD7684 Section	. 14
Updated Outline Dimensions	. 15
Changes to Ordering Guide	. 15

10/04— Revision 0: Initial Version

### **SPECIFICATIONS**

VDD = 2.7 V to 5.5 V;  $V_{REF}$  = VDD;  $T_A$  = -40°C to +85°C, unless otherwise noted.

#### Table 2.

Parameter	Conditions	Min	Тур	Max	Unit	
RESOLUTION		16			Bits	
ANALOG INPUT						
Voltage Range <sup>1</sup>	+IN – (–IN)	-V <sub>REF</sub>		+V <sub>REF</sub>	V	
Absolute Input Voltage	+IN, -IN	-0.1		VDD + 0.1	V	
Common-Mode Input Range	+IN, -IN	0	$V_{\text{REF}}/2$	$V_{REF}/2 + 0.1$	V	
Analog Input CMRR	$f_{IN} = 100 \text{ kHz}$		65		dB	
Leakage Current at 25°C	Acquisition phase		1		nA	
Input Impedance		See th	ne Analog Inp	outs section		
THROUGHPUT SPEED						
Complete Cycle				10	μs	
Throughput Rate		0		100	kSPS	
DCLOCK Frequency		0		2.9	MHz	
REFERENCE						
Voltage Range		0.5		VDD + 0.3	V	
Load Current	100 kSPS, $V_{+IN} = V_{-IN} = V_{REF}/2 = 2.5 V$		50		μA	
DIGITAL INPUTS						
Logic Levels						
VIL		-0.3		$0.3 \times VDD$	V	
VIH		$0.7 \times VDD$		VDD + 0.3	V	
lı.		-1		+1	μA	
Іщ		-1		+1	μA	
Input Capacitance			5		pF	
DIGITAL OUTPUTS						
Data Format		Serial	16 bits twos c	omplement		
V <sub>OH</sub>	$I_{SOURCE} = -500 \mu A$	VDD - 0.3			V	
Vol	I <sub>SINK</sub> = +500 μA			0.4	V	
POWER SUPPLIES						
VDD	Specified performance	2.7		5.5	V	
VDD Range <sup>2</sup>	-	2.0		5.5	V	
Operating Current	100 kSPS throughput					
-	VDD = 5 V		800		μA	
	VDD = 2.7 V		560		μA	
Standby Current <sup>3, 4</sup>	VDD = 5 V, 25°C		1	50	nA	
Power Dissipation	VDD = 5 V		4	6	mW	
	VDD = 2.7 V		1.5		mW	
	VDD = 2.7 V, 10 kSPS throughput <sup>3</sup>		150		μW	
TEMPERATURE RANGE						
Specified Performance	T <sub>MIN</sub> to T <sub>MAX</sub>	-40			°C	

<sup>1</sup> The inputs must be driven differentially 180° from each other. See Pin Configuration and Function Descriptions and Analog Inputs sections.

<sup>2</sup> See the Typical Performance Characteristics section for more information.
 <sup>3</sup> With all digital inputs forced to VDD or GND, as required.
 <sup>4</sup> During acquisition phase.

$VDD = 5 V: V_{REE} = V$	VDD; $T_A = -40^{\circ}C$ to $\cdot$	+85°C, unless	otherwise noted.
1 D D 0 1, 1 KLI	10010	105 O, ameoo	other white moteur.

#### Table 3.

Parameter	Conditions	Min	Тур	Max	Unit
ACCURACY					
No Missing Codes		16			Bits
Integral Linearity Error		-3	±1	+3	LSB
Transition Noise			0.5		LSB
Gain Error, $^1$ T <sub>MIN</sub> to T <sub>MAX</sub>			±2	±15	LSB
Gain Error Temperature Drift			±0.3		ppm/°C
Zero Error, <sup>1</sup> T <sub>MIN</sub> to T <sub>MAX</sub>			±0.4	±1.6	mV
Zero Temperature Drift			±0.3		ppm/°C
Power Supply Sensitivity	$VDD = 5 V \pm 5\%$		±0.05		LSB
AC ACCURACY					
Signal-to-Noise Ratio	f <sub>IN</sub> = 1 kHz	88	91		dB <sup>2</sup>
Spurious-Free Dynamic Range	$f_{IN} = 1 \text{ kHz}$		-108		dB
Total Harmonic Distortion $f_{IN} = 1 \text{ kHz}$			-106		dB
Signal-to-(Noise + Distortion)	f <sub>IN</sub> = 1 kHz	88 91		dB	
Effective Number of Bits	f <sub>IN</sub> = 1 kHz		14.8		Bits

<sup>1</sup> See the Terminology section. These specifications include full temperature range variation but do not include the error contribution from the external reference. <sup>2</sup> All specifications in dB are referred to a full-scale input, FS. Tested with an input signal at 0.5 dB below full scale, unless otherwise specified.

VDD = 2.7 V;  $V_{REF}$  = 2.5 V;  $T_A$  = -40°C to +85°C, unless otherwise noted.

Parameter	Conditions	Min	Тур	Max	Unit
ACCURACY					
No Missing Codes		16			Bits
Integral Linearity Error		-3	±1	+3	LSB
Transition Noise			0.85		LSB
Gain Error, <sup>1</sup> T <sub>MIN</sub> to T <sub>MAX</sub>			±2	±15	LSB
Gain Error Temperature Drift			±0.3		ppm/°C
Zero Error, <sup>1</sup> T <sub>MIN</sub> to T <sub>MAX</sub>			±0.7	±3.5	mV
Zero Temperature Drift			±0.3		ppm/°C
Power Supply Sensitivity	VDD = 2.7 V ± 5%		±0.05		LSB
AC ACCURACY					
Signal-to-Noise Ratio	$f_{IN} = 1 \text{ kHz}$		86		dB <sup>2</sup>
Spurious-Free Dynamic Range $f_{IN} = 1 \text{ kHz}$			-100		dB
Total Harmonic Distortion $f_{IN} = 1 \text{ kHz}$			-98		dB
Signal-to-(Noise + Distortion)	f <sub>IN</sub> = 1 kHz		86		dB
Effective Number of Bits	$f_{IN} = 1 \text{ kHz}$		14		Bits

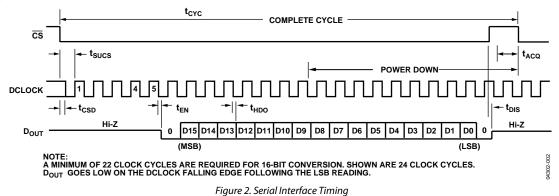
<sup>1</sup> See the Terminology section. These specifications do include full temperature range variation but do not include the error contribution from the external reference. <sup>2</sup> All specifications in dB are referred to a full-scale input, FS. Tested with an input signal at 0.5 dB below full scale, unless otherwise specified.

### TIMING SPECIFICATIONS

VDD = 2.7 V to 5.5 V,  $T_A = -40^{\circ}$ C to +85°C, unless otherwise noted.

Table 5.							
Parameter	Symbol	Min	Тур	Мах	Unit		
Throughput Rate	t <sub>cyc</sub>			100	kHz		
CS Falling to DCLOCK Low	t <sub>CSD</sub>			0	μs		
CS Falling to DCLOCK Rising	tsucs	20			ns		
DCLOCK Falling to Data Remains Valid	t <sub>HDO</sub>	5	16		ns		
CS Rising Edge to Dout High Impedance	t <sub>DIS</sub>		14	100	ns		
DCLOCK Falling to Data Valid	t <sub>en</sub>		16	50	ns		
Acquisition Time	t <sub>ACQ</sub>	400			ns		
Dout Fall Time	t <sub>F</sub>		11	25	ns		
Dout Rise Time	t <sub>R</sub>		11	25	ns		

#### **Timing Diagrams**



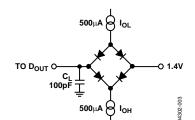


Figure 3. Load Circuit for Digital Interface Timing

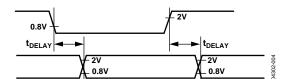


Figure 4. Voltage Reference Levels for Timing



Figure 5. DOUT Rise and Fall Timing

### **ABSOLUTE MAXIMUM RATINGS**

#### Table 6.

Parameter	Rating
Analog Inputs	
$+IN^1$ , $-IN^1$	GND – 0.3 V to VDD + 0.3 V or ±130 mA
REF	GND – 0.3 V to VDD + 0.3 V
Supply Voltages	
VDD to GND	–0.3 V to +6 V
Digital Inputs to GND	–0.3 V to VDD + 0.3 V
Digital Outputs to GND	–0.3 V to VDD + 0.3 V
Storage Temperature Range	–65°C to +150°C
Junction Temperature	150°C
$\theta_{JA}$ Thermal Impedance	200°C/W
θ <sub>JC</sub> Thermal Impedance	44°C/W
Lead Temperature	JEDEC J-STD-20

<sup>1</sup> See the Analog Inputs section.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# **PIN CONFIGURATION AND FUNCTION DESCRIPTIONS**

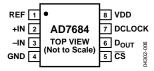


Figure 6. 8-Lead MSOP Pin Configuration

#### Table 7. Pin Function Descriptions

Pin No.	Mnemonic	Type <sup>1</sup>	Description
1	REF	AI	Reference Input Voltage. The REF range is from 0.5 V to VDD. This pin is referred to the GND pin and should be decoupled closely to the GND pin with a ceramic capacitor of a few $\mu$ F.
2	+IN	AI	Differential Positive Analog Input. Referenced to $-IN$ . The input range for $+IN$ is between 0 V and V <sub>REF</sub> , centered about V <sub>REF</sub> /2 and must be driven 180° out of phase with $-IN$ .
3	-IN	AI	Differential Negative Analog Input. Referenced to +IN. The input range for –IN is between $V_{REF}$ and 0 V, centered about $V_{REF}/2$ and must be driven 180° out of phase with +IN.
4	GND	Р	Power Supply Ground.
5	<u>cs</u>	DI	Chip Select Input. On its falling edge, it initiates the conversions. The part returns to shutdown mode as soon as the conversion is complete. It also enables Dout. When high, Dout is high impedance.
6	Dout	DO	Serial Data Output. The conversion result is output on this pin. It is synchronized to DCLOCK.
7	DCLOCK	DI	Serial Data Clock Input.
8	VDD	Р	Power Supply.

 $^{1}$  AI = analog input, DI = digital input, DO = digital output, and P = power.

### TERMINOLOGY

#### Integral Nonlinearity Error (INL)

Linearity error refers to the deviation of each individual code from a line drawn from negative full scale through positive full scale. The point used as negative full scale occurs ½ LSB before the first code transition. Positive full scale is defined as a level 1½ LSB beyond the last code transition. The deviation is measured from the middle of each code to the true straight line (see Figure 21).

#### Differential Nonlinearity Error (DNL)

In an ideal ADC, code transitions are 1 LSB apart. DNL is the maximum deviation from this ideal value. It is often specified in terms of resolution for which no missing codes are guaranteed.

#### Zero Error

Zero error is the difference between the ideal midscale voltage, that is, 0 V, and the actual voltage producing the midscale output code, that is, 0 LSB.

#### **Gain Error**

The first transition (from  $100 \dots 00$  to  $100 \dots 01$ ) should occur at a level ½ LSB above the nominal negative full scale (-4.999924 V for the ±5 V range). The last transition (from 011...10 to 011...11) should occur for an analog voltage 1½ LSB below the nominal full scale (4.999771 V for the ±5 V range). The gain error is the deviation of the difference between the actual level of the last transition and the actual level of the first transition from the difference between the ideal levels.

#### Spurious-Free Dynamic Range (SFDR)

SFDR is the difference, in decibels (dB), between the rms amplitude of the input signal and the peak spurious signal.

#### Effective Number of Bits (ENOB)

ENOB is a measurement of the resolution with a sine wave input. It is related to SINAD by the following formula

 $ENOB = (SINAD_{dB} - 1.76)/6.02$ 

and is expressed in bits.

#### **Total Harmonic Distortion (THD)**

THD is the ratio of the rms sum of the first five harmonic components to the rms value of a full-scale input signal and is expressed in dB.

#### Signal-to-Noise Ratio (SNR)

SNR is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components below the Nyquist frequency, excluding harmonics and dc. The value for SNR is expressed in dB.

#### Signal-to-(Noise + Distortion) Ratio (SINAD)

SINAD is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc. The value for SINAD is expressed in dB.

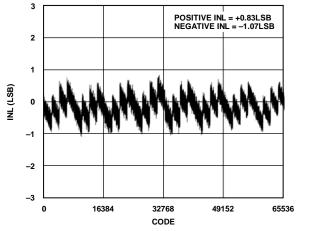
#### Aperture Delay

Aperture delay is a measure of the acquisition performance and is the time between the falling edge of the  $\overline{CS}$  input and when the input signal is held for a conversion.

#### **Transient Response**

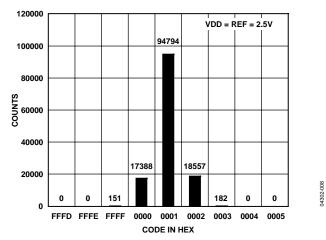
Transient response is the time required for the ADC to accurately acquire its input after a full-scale step function is applied.

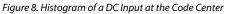
### **TYPICAL PERFORMANCE CHARACTERISTICS**

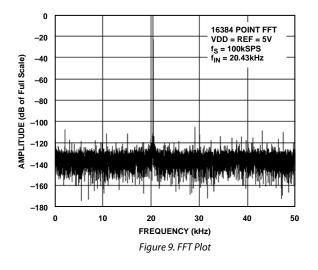


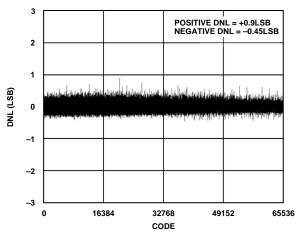


04302-007











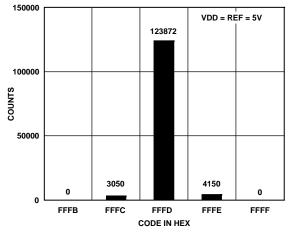
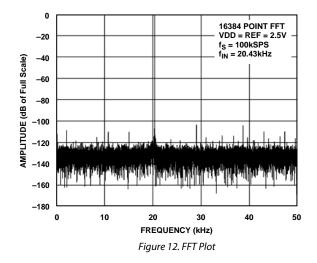
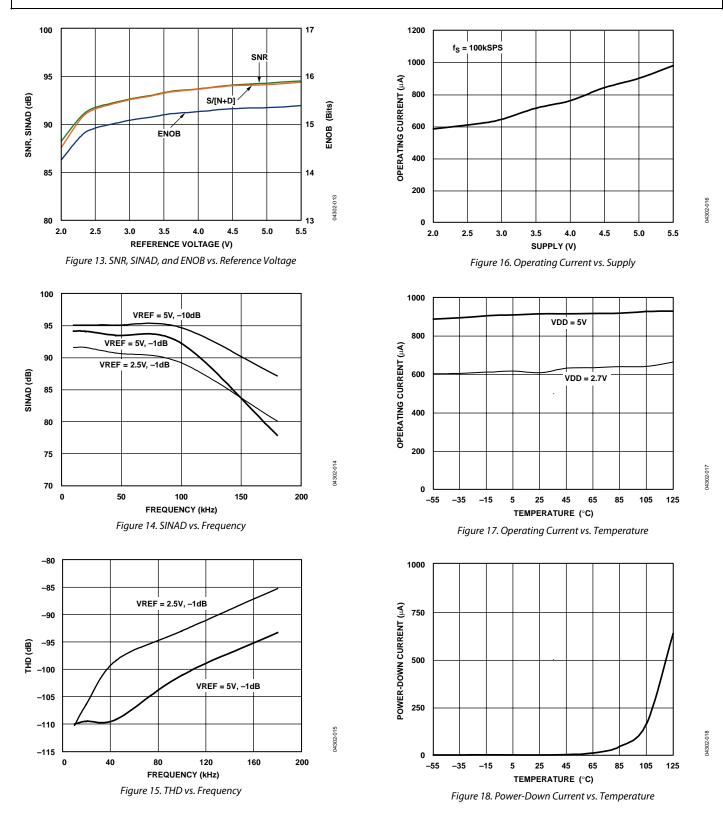


Figure 11. Histogram of a DC Input at the Code Center



04302-010

04302-009



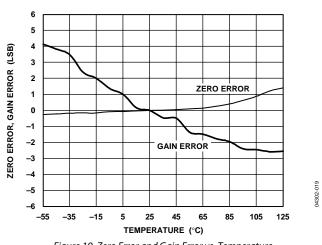


Figure 19. Zero Error and Gain Error vs. Temperature

### **APPLICATION INFORMATION**

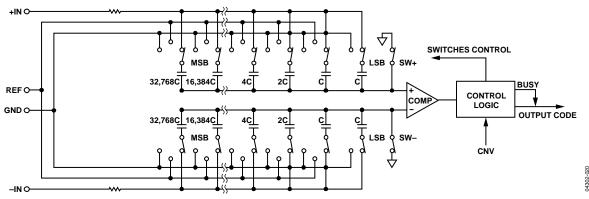


Figure 20. ADC Simplified Schematic

### **CIRCUIT INFORMATION**

The AD7684 is a low power, single-supply, 16-bit ADC using a successive approximation architecture. It is capable of converting 100,000 samples per second (100 kSPS) and powers down between conversions. When operating at 10 kSPS, for example, it consumes typically 150  $\mu$ W with a 2.7 V supply, ideal for battery-powered applications.

The AD7684 provides the user with an on-chip, track-and-hold and does not exhibit any pipeline delay or latency, making it ideal for multiple, multiplexed channel applications.

The AD7684 is specified from 2.7 V to 5.5 V. It is housed in an 8-lead MSOP.

### **CONVERTER OPERATION**

The AD7684 is a successive approximation ADC based on a charge redistribution DAC. Figure 20 shows the simplified schematic of the ADC. The capacitive DAC consists of two identical arrays of 16 binary-weighted capacitors, which are connected to the two comparator inputs.

During the acquisition phase, terminals of the array tied to the input of the comparator are connected to GND via SW+ and SW-. All independent switches are connected to the analog inputs. Therefore, the capacitor arrays are used as sampling capacitors and acquire the analog signal on the +IN and -IN inputs. When the acquisition phase is complete and the CS input goes low, a conversion phase is initiated. When the conversion phase begins, SW+ and SW- are opened first. The two capacitor arrays are then disconnected from the inputs and connected to the GND input. Therefore, the differential voltage between the inputs, +IN and -IN, captured at the end of the acquisition phase is applied to the comparator inputs, causing the comparator to become unbalanced. By switching each element of the capacitor array between GND and REF, the comparator input varies by binary-weighted voltage steps (V<sub>REF</sub>/2, V<sub>REF</sub>/4...V<sub>REF</sub>/65,536). The control logic toggles these switches, starting with the MSB, to bring the comparator back

into a balanced condition. After the completion of this process, the part returns to the acquisition phase and the control logic generates the ADC output code.

### **TRANSFER FUNCTIONS**

The ideal transfer function for the AD7684 is shown in Figure 21 and Table 8.

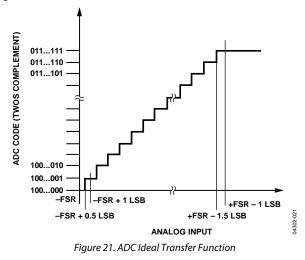
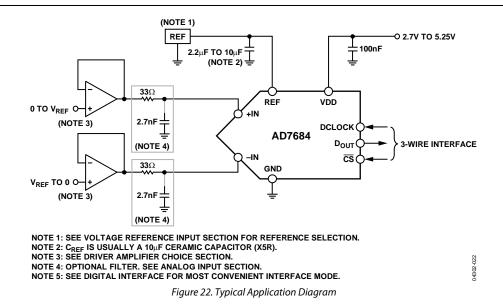


Table 8.	Output	Codes	and Ide	al Input	Voltages
----------	--------	-------	---------	----------	----------

Description	Analog Input V <sub>REF</sub> = 5 V	Digital Output Code Hex
FSR – 1 LSB	+4.999847 V	7FFF <sup>1</sup>
Midscale + 1 LSB	+152.6 μV	0001
Midscale	0 V	0000
Midscale – 1 LSB	–152.6 μV	FFFF
–FSR + 1 LSB	-4.999847 V	8001
–FSR	-5 V	8000 <sup>2</sup>

 $^{1}$  This is also the code for an overranged analog input (V\_{+IN}-V\_{-IN} above  $V_{\text{REF}}-V_{\text{GND}}).$ 

 $^2$  This is also the code for an underranged analog input (V\_{+IN} - V\_{-IN} below  $-V_{REF}$  + V\_{GND}).



### **TYPICAL CONNECTION DIAGRAM**

Figure 22 shows an example of the recommended application diagram for the AD7684.

### **ANALOG INPUTS**

The analog inputs (+IN, –IN) need to be driven differentially 180° from each other, as shown in Figure 22. Holding either input at GND or a fixed dc gives erroneous conversion results because the AD7684 is intended for differential operation only. For applications requiring –IN to be at GND (±100 mV), the AD7683 should be used.

Figure 23 shows an equivalent circuit of the input structure of the AD7684. The two diodes, D1 and D2, provide ESD protection for the analog inputs, +IN and –IN. Care must be taken to ensure that the analog input signal never exceeds the supply rails by more than 0.3 V because this causes these diodes to become forward-biased and start conducting current. However, these diodes can handle a forward-biased current of 130 mA maximum. For instance, these conditions could eventually occur when the supplies of the input buffer (U1) are different from VDD. In such a case, an input buffer with a short-circuit current limitation can be used to protect the part.

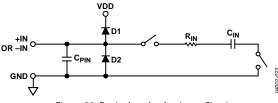


Figure 23. Equivalent Analog Input Circuit

This analog input structure allows the sampling of the differential signal between +IN and –IN. By using this differential input, small signals common to both inputs are rejected. During the acquisition phase, the impedance of the analog inputs can be modeled as a parallel combination of the Capacitor  $C_{PIN}$  and the network formed by the series connection of  $R_{IN}$  and  $C_{IN}$ .  $C_{PIN}$  is primarily

the pin capacitance.  $R_{IN}$  is typically 600  $\Omega$  and is a lumped component made up of some serial resistors and the onresistance of the switches.  $C_{IN}$  is typically 30 pF and is mainly the ADC sampling capacitor. During the conversion phase, when the switches are opened, the input impedance is limited to  $C_{PIN}$ .  $R_{IN}$  and  $C_{IN}$  make a 1-pole, low-pass filter that reduces undesirable aliasing effects and limits the noise.

When the source impedance of the driving circuit is low, the AD7684 can be driven directly. Large source impedances significantly affect the ac performance, especially THD. The dc performances are less sensitive to the input impedance.

#### **DRIVER AMPLIFIER CHOICE**

Although the AD7684 is easy to drive, the driver amplifier needs to meet the following requirements:

- The noise generated by the driver amplifier needs to be kept as low as possible to preserve the SNR and transition noise performance of the AD7684. Note that the AD7684 has a noise level much lower than most other 16-bit ADCs and, therefore, can be driven by a noisier op amp while preserving the same or better system performance. The noise coming from the driver is filtered by the AD7684 analog input circuit 1-pole, low-pass filter made by R<sub>IN</sub> and C<sub>IN</sub> or by the external filter, if one is used.
- For ac applications, the driver needs to have a THD performance commensurate with the AD7684. Figure 15 shows the THD vs. frequency that the driver should exceed.
- For multichannel multiplexed applications, the driver amplifier and the AD7684 analog input circuit must be able to settle for a full-scale step of the capacitor array at a 16-bit level (0.0015%). In the data sheet of the amplifier, settling at 0.1% to 0.01% is more commonly specified. This could differ significantly from the settling time at a 16-bit level and should be verified prior to driver selection.

#### Table 9. Recommended Driver Amplifiers

Amplifier	Typical Application			
ADA4841-x	Very low noise			
ADA4941-1	Very low noise, single to differential			
AD8021	Very low noise and high frequency			
AD8022	Low noise and high frequency			
OP184	Low power, low noise, and low frequency			
AD8605, AD8615	5 V single-supply, low power			
AD8519	Small, low power, and low frequency			
AD8031	High frequency and low power			

#### **VOLTAGE REFERENCE INPUT**

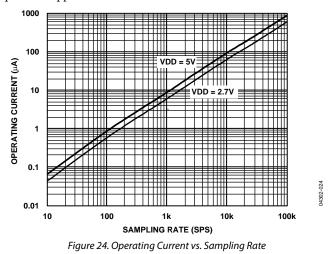
The AD7684 voltage reference input, REF, has a dynamic input impedance. It should therefore be driven by a low impedance source with efficient decoupling between the REF and GND pins, as explained in more detail in the Layout section.

When REF is driven by a very low impedance source (for example, an unbuffered reference voltage such as the low temperature drift ADR43x reference or a reference buffer using the AD8031 or the AD8605), a 10  $\mu$ F (X5R, 0805 size) ceramic chip capacitor is appropriate for optimum performance.

If desired, smaller reference decoupling capacitor values down to 2.2  $\mu F$  can be used with minimal impact on performance, especially DNL.

### **POWER SUPPLY**

The AD7684 powers down automatically at the end of each conversion phase and therefore the power scales linearly with the sampling rate, as shown in Figure 24. This makes the part ideal for low sampling rates (even of a few Hz) and low battery powered applications.



#### **DIGITAL INTERFACE**

The AD7684 is compatible with SPI, QSPI, digital hosts, and DSPs (for example, Blackfin<sup>®</sup> ADSP-BF53x or ADSP-219x). The connection diagram is shown in Figure 25, and the corresponding timing is given in Figure 2.

A falling edge on  $\overline{CS}$  initiates a conversion and the data transfer. After the fifth DCLOCK falling edge, D<sub>OUT</sub> is enabled and forced low. The data bits are then clocked MSB first by subsequent DCLOCK falling edges. The data is valid on both DCLOCK edges. Although the rising edge can be used to capture the data, a digital host also using the DCLOCK falling edge allows a faster reading rate, provided it has an acceptable hold time.

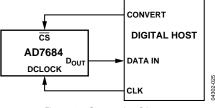


Figure 25. Connection Diagram

### LAYOUT

The printed circuit board housing the AD7684 should be designed so that the analog and digital sections are separated and confined to certain areas of the board. The pinout of the AD7684 with all its analog signals on the left side and all its digital signals on the right side eases this task.

Avoid running digital lines under the device because these couple noise onto the die, unless a ground plane under the AD7684 is used as a shield. Fast switching signals, such as  $\overline{\text{CS}}$  or clocks, should never run near analog signal paths. Crossover of digital and analog signals should be avoided.

At least one ground plane should be used. It could be common or split between the digital and analog sections. In such a case, it should be joined underneath the AD7684.

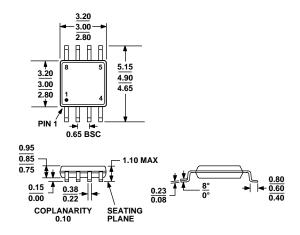
The AD7684 voltage reference input REF has a dynamic input impedance and should be decoupled with minimal parasitic inductances. This is done by placing the reference decoupling ceramic capacitor close to, and ideally right up against, the REF and GND pins and by connecting these pins with wide, low impedance traces.

Finally, the power supply, VDD, of the AD7684 should be decoupled with a ceramic capacitor, typically 100 nF, and placed close to the AD7684. It should be connected using short and large traces to provide low impedance paths and reduce the effect of glitches on the power supply lines.

### **EVALUATING THE PERFORMANCE OF THE AD7684**

Other recommended layouts for the AD7684 are outlined in the evaluation board for the AD7684 (EVAL-AD7684CBZ). The evaluation board package includes a fully assembled and tested evaluation board, documentation, and software for controlling the board from a PC via the EVAL-CONTROL BRD3Z.

### **OUTLINE DIMENSIONS**



COMPLIANT TO JEDEC STANDARDS MO-187-AA

Figure 26. 8-Lead Mini Small Outline Package [MSOP] (RM-8) Dimensions shown in millimeters

#### **ORDERING GUIDE**

Model	Integral Nonlinearity	Temperature Range	Package Description	Package Option	Ordering Quantity	Branding
AD7684BRM	±3 LSB maximum	–40°C to +85°C	8-Lead MSOP	RM-8	50	C1D
AD7684BRMRL7	±3 LSB maximum	–40°C to +85°C	8-Lead MSOP	RM-8	1,000	C1D
AD7684BRMZ <sup>1</sup>	±3 LSB maximum	–40°C to +85°C	8-Lead MSOP	RM-8	50	C39
AD7684BRMZRL7 <sup>1</sup>	±3 LSB maximum	–40°C to +85°C	8-Lead MSOP	RM-8	1,000	C39
EVAL-AD7684CBZ <sup>1, 2</sup>			Evaluation Board			
EVAL-CONTROL BRD3Z <sup>1, 3</sup>			Controller Board			

 $^{1}$  Z = RoHS Compliant Part.

<sup>2</sup> This board can be used as a standalone evaluation board or in conjunction with the EVAL-CONTROL BRDx for evaluation/demonstration purposes.
 <sup>3</sup> This board allows a PC to control and communicate with all the Analog Devices, Inc. evaluation boards ending in the CB designators.

# NOTES



www.analog.com

©2004–2007 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners. D04302-0-10/07(A)

Rev. A | Page 16 of 16

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Analog Devices Inc.: AD7684BRMZRL7 AD7684BRMZ